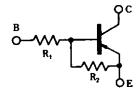


COMPOUND TRANSISTOR HQ1 SERIES

on-chip resistor PNP silicon epitaxial transistor For mid-speed switching

FEATURES

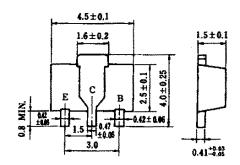
- Up to 2A high current drives such as ICs, motors, and solenoids available
- On-chip bias resistor
- Low power consumption during drive



HQ1 SERIES LISTS

Products	Marking	R ₁ (KΩ)	R_2 (K Ω)
HQ1L2N	DP	0.47	1.0
HQ1A3M	DQ	1.0	1.0
HQ1F3M	DR	2.2	2.2
HQ1F3P	DS	2.2	10
HQ1L2Q	DT	0.47	4.7
HQ1F2Q	DU	0.22	2.2
HQ1A4A	DX	_	10

PACKAGE DRAWING (UNIT: mm)



Electrode Connection

E: Emitter
C: Collector(Fin)

B : Base

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	Vсво	-20	V
Collector to emitter voltage	Vceo	-20	V
Emitter to base voltage	VEBO	-10	V
Collector current (DC)	Ic(DC)	-2.0	Α
Collector current (Pulse)	IC(pulse) *	-3.0	Α
Base current (DC)	I _{B(DC)}	-0.04	Α
Total power dissipation	P _T **	2.0	W
Junction temperature	Tj	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

^{*} PW \leq 10 ms, duty cycle \leq 50 %

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

^{**} When 0.7 mm \times 16 cm² ceramic board is used



HQ1L2N ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = −20 V, IE = 0			-100	nA
DC current gain	h _{FE1} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.1 \text{ A}$	50			-
DC current gain	h _{FE2} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -1.0 \text{ A}$	150			_
DC current gain	h _{FE3} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -2.0 \text{ A}$	50			-
Low level output voltage	V OL **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.7 \text{ A}$			-0.55	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			-0.3	V
Input resistance	R ₁		329	470	611	Ω
E-to-B resistance	R ₂		0.7	1.0	1.3	kΩ

^{**} PW \leq 350 μ s, duty cycle \leq 2 %

HQ1A3M ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	V _{CB} = -20 V, I _E = 0			-100	nA
DC current gain	h _{FE1} **	Vce = -2.0 V, Ic = -0.1 A	50			-
DC current gain	h _{FE2} **	Vce = -2.0 V, Ic = -1.0 A	100			-
DC current gain	h _{FE3} **	$V_{CE} = -2.0 \text{ V}, I_{C} = -2.0 \text{ A}$	50			-
Low level output voltage	Vol **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}$			-0.4	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V, } I_{C} = -100 \ \mu\text{A}$			-0.3	V
Input resistance	R ₁		0.7	1.0	1.3	kΩ
E-to-B resistance	R ₂		0.7	1.0	1.3	kΩ

^{**} PW \leq 350 μ s, duty cycle \leq 2 %

HQ1F3M ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = -20 V, IE = 0			-100	nA
DC current gain	h _{FE1} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.1 \text{ A}$	80			-
DC current gain	h _{FE2} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -1.0 \text{ A}$	150			ı
DC current gain	h _{FE3} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -2.0 \text{ A}$	50			ı
Low level output voltage	V ol **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.3 \text{ A}$			-0.3	٧
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			-0.3	V
Input resistance	R ₁		1.54	2.2	2.86	kΩ
E-to-B resistance	R ₂		1.54	2.2	2.86	kΩ

^{**} PW \leq 350 μ s, duty cycle \leq 2 %



HQ1F3P ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = -20 V, IE = 0			-100	nA
DC current gain	h _{FE1} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.1 \text{ A}$	200			-
DC current gain	h _{FE2} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -1.0 \text{ A}$	150			_
DC current gain	h _{FE3} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -2.0 \text{ A}$	50			-
Low level output voltage	V ol **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.3 \text{ A}$			-0.3	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			-0.3	V
Input resistance	R ₁		1.54	2.2	2.86	kΩ
E-to-B resistance	R ₂		7	10	13	kΩ

^{**} PW \leq 350 μ s, duty cycle \leq 2 %

HQ1L2Q ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = −20 V, IE = 0			-100	nA
DC current gain	h _{FE1} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.1 \text{ A}$	150			_
DC current gain	hFE2 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -1.0 \text{ A}$	150			-
DC current gain	h _{FE3} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -2.0 \text{ A}$	50			_
Low level output voltage	V ol **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.7 \text{ A}$			-0.55	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			-0.3	٧
Input resistance	R ₁		329	470	611	Ω
E-to-B resistance	R ₂		3.29	4.7	6.11	kΩ

^{**} PW \leq 350 μ s, duty cycle \leq 2 %

HQ1F2Q ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = -20 V, IE = 0			-100	nA
DC current gain	h _{FE1} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.1 \text{ A}$	80			-
DC current gain	h _{FE2} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -1.0 \text{ A}$	150			1
DC current gain	h _{FE3} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -2.0 \text{ A}$	50			1
Low level output voltage	Vol **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.7 \text{ A}$			-0.55	٧
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			-0.3	V
Input resistance	R ₁		154	220	286	kΩ
E-to-B resistance	R ₂		1.54	2.2	2.86	kΩ

^{**} PW \leq 350 μ s, duty cycle \leq 2 %

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HQ1A4A ELECTRICAL CHARACTERISTICS (Ta = 25°C)

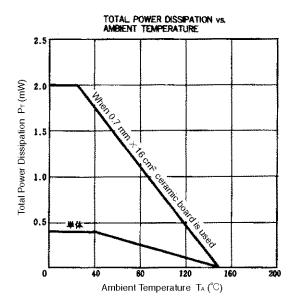
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = −20 V, IE = 0			-100	nA
DC current gain	h _{FE1} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.1 \text{ A}$	200			-
DC current gain	h _{FE2} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -1.0 \text{ A}$	150			-
DC current gain	h _{FE3} **	$V_{CE} = -2.0 \text{ V}, I_{C} = -2.0 \text{ A}$	50			-
Collector saturation voltage	V _{CE(sat)} **	$I_{C} = -1.0 \text{ A}, I_{B} = -20 \text{ mA}$		-0.35	-0.45	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			-0.3	V
Input resistance	R ₁		_	_	_	Ω
E-to-B resistance	R ₂		7	10	13	kΩ

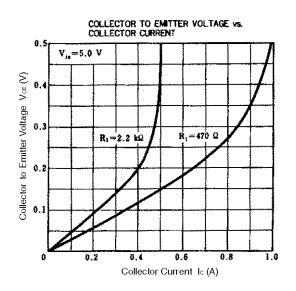
^{**} PW \leq 350 μ s, duty cycle \leq 2 %

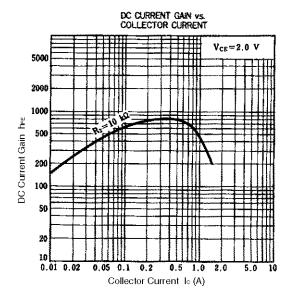
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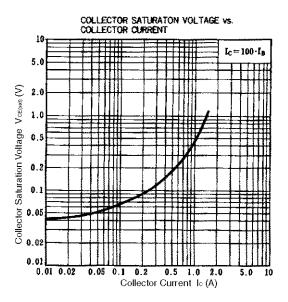


TYPICAL CHARACTERISTICS (Ta = 25°C)









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